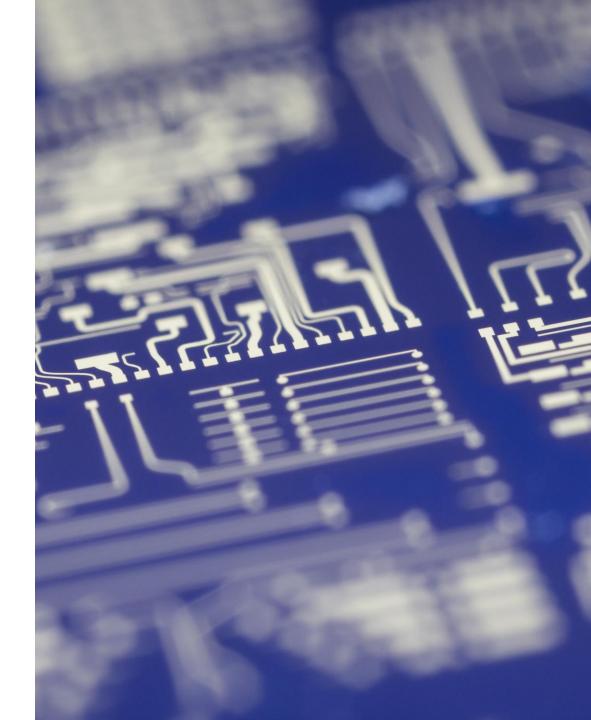
SMART PHOTONICS

EPIC General meeting – April 7th 2022

AGENDA

- Introduction to SMART Photonics
- Industry developments
- InP pilot line building
- Dedicated Wafers and Multi-Project Wafer Runs
- PDK approach
- Summary





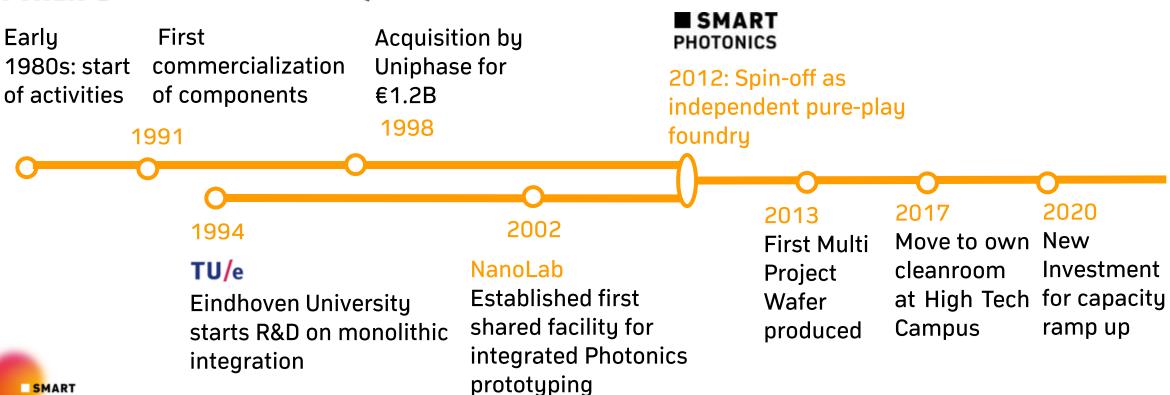
OUR HERITAGE: MADE IN EINDHOVEN

🔎 JDS Uniphase



PHILIPS

PHOTONICS



VISION AND MISSION FOR SMART PHOTONICS

OUR VISION

Integrated Photonics is used everywhere around us and improves the quality of our everyday lives.

OUR MISSION

To be the leading foundry and development partner in integrated photonics that works closely together with our customers to create innovative products that improve people's lives.

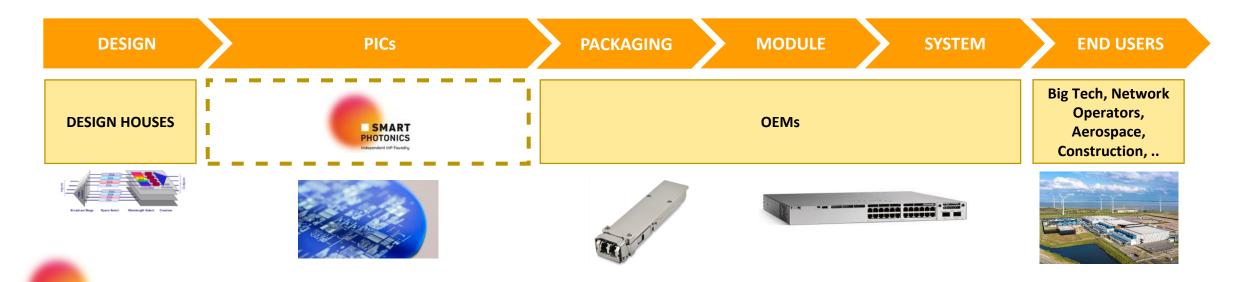




SMART PHOTONICS

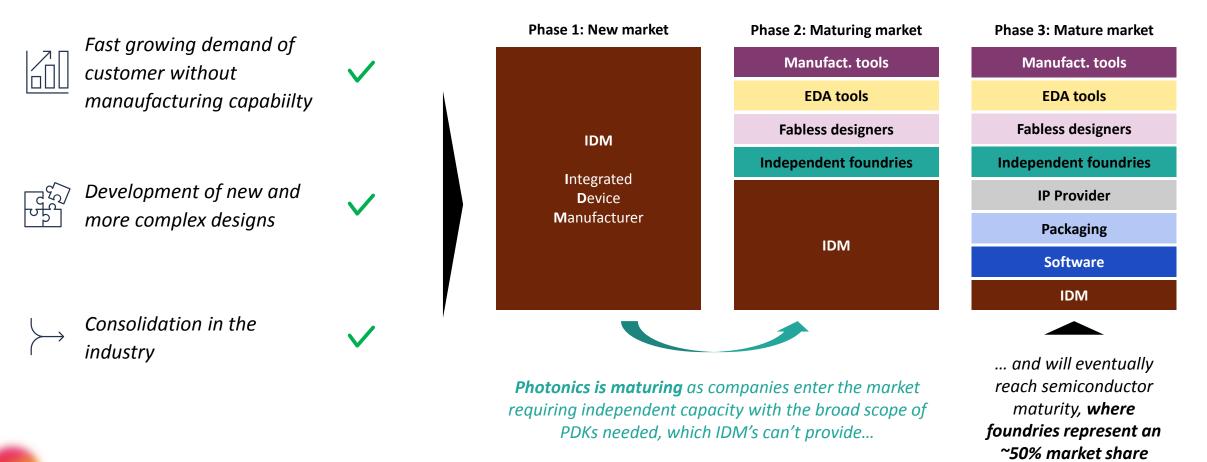
SMART

- We are producing Photonics chips: chips based on light instead of electronics
- We are the first player offering production of integrated photonic chips as a foundry.
- Our customers are predominantly OEMs and system companies
- Providing prototyping services and volume production



PHOTONICS FOLLOWS SEMICON IN VALUE CHAIN DEVELOPMENT

Trends in the market...



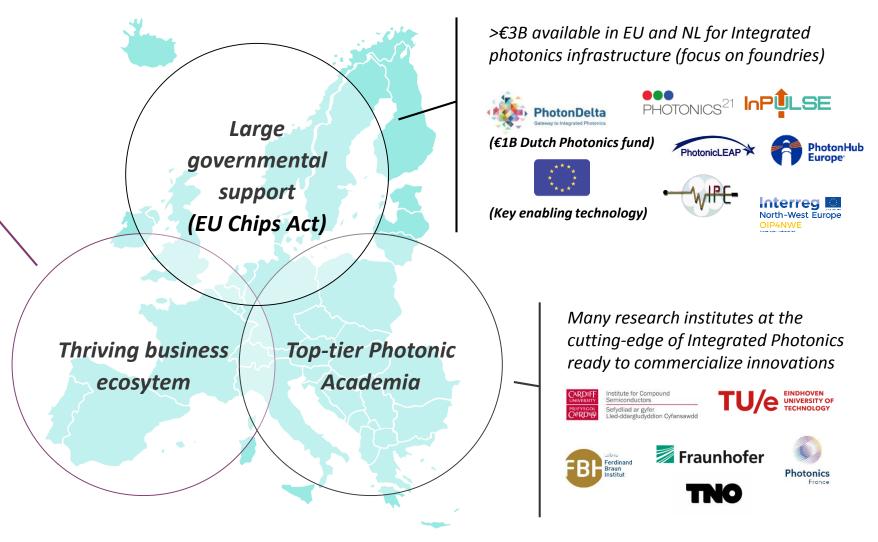
... driving a similar shift from integrated manufacturers to foundries



GEOPOLITICS DRIVES EU TO STRONGLY INVEST IN PHOTONICS

Large ecosystem of fabless designers, system integrators, design tool providers, packaging companies, ...





SMART PHOTONICS

FUNDING 2020/21

- Realized major funding round of € 35 M June 2020
- Added € 13 M non-equity financing in June 2021

Major targets

- Demonstrate Low Volume Manufacturing
- Increased capacity and yield
- Customers in production phase





STATE OF THE ART MANUFACTURING FACILITIES

SMART Photonics at High Tech Campus Eindhoven

- 1400m² Production facility
 - >1000m² 3" Production cleanroom (Class 1000)
 - Back-end, testing and layer growth capabilities

SMART Photonics at Nanolab

Eindhoven University of Technology Science Park

850m² Fully equipped R&D facility

Processing and epitaxy expertise at both sites



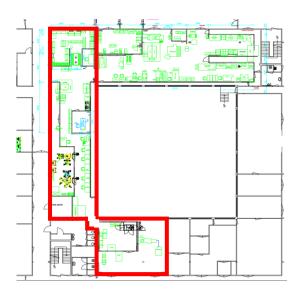




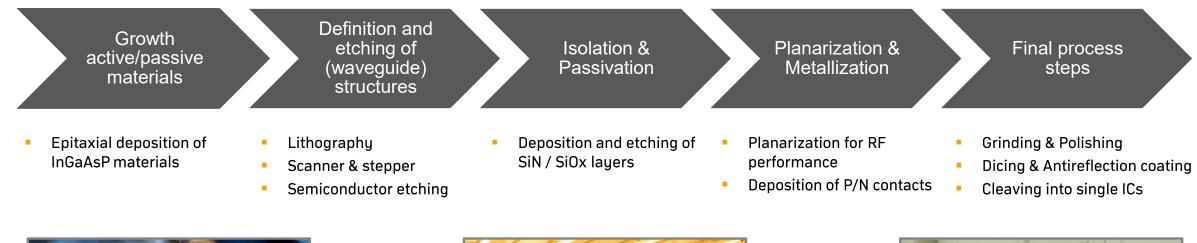
BUILD-OUT IN NUMBERS

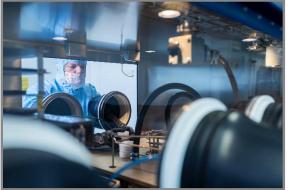
- 25 Tools
 - ~60 vendors contacted and ~75 tools assessed
 - More than 2000 pages of specification
- Close to 200 process steps to be transferred, modified, reconfigured or newly developed
 - Move from shared facilities at University to own facility
 - And/or between tools
 - Fully new processes
- More than 2 x size of cleanroom
- Building the ICT infrastructure to monitor, control and plan the line
- Close to 60 new FMEA's, Control Plans and SPC implementations
- Integrate/train 70 new people





SMART IS COVERING THE OVERALL PROCESS







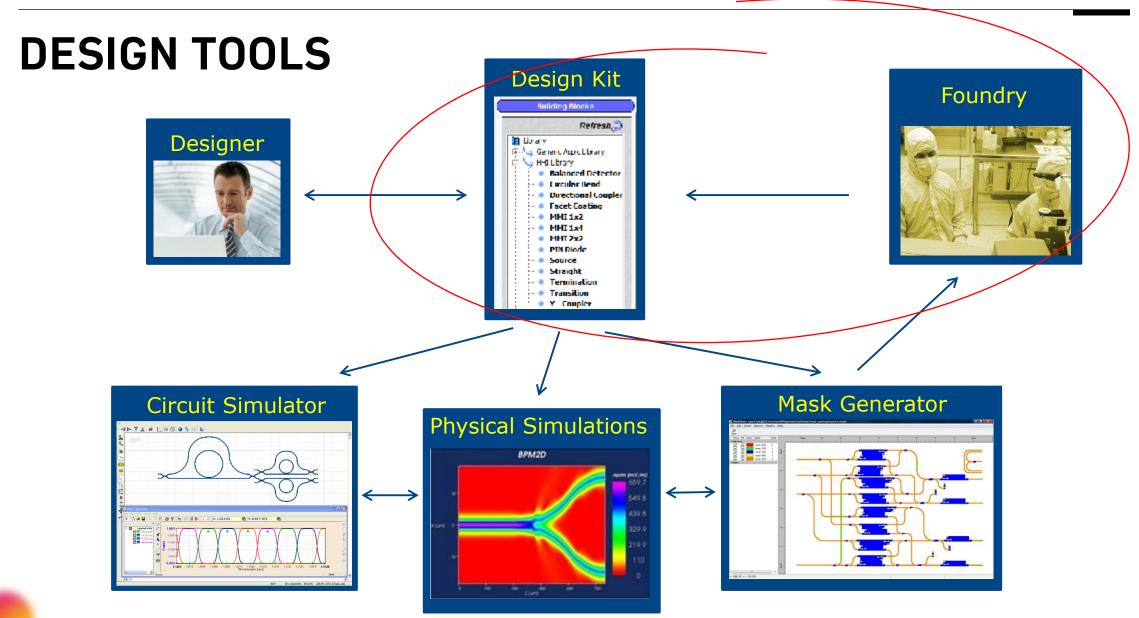




STATUS AND GROWTH PLANS

- Release of production line
 - All equipment released
 - Transition from manual process to semi-automated realized. Nearly all process modifications released.
 - Scale up to 3k wafer/yr (3") by end of 2022, 5k wafers/yr by end of 2023
 - Production line is 4" capable first demonstration in 2022
 - Split production line and R&D facilities
- Increase wafer and die testing capabilities
- Longer term, we intend to expand further, based on blue-print of current facility



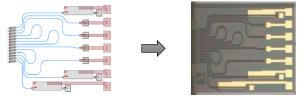


SMART PHOTONICS

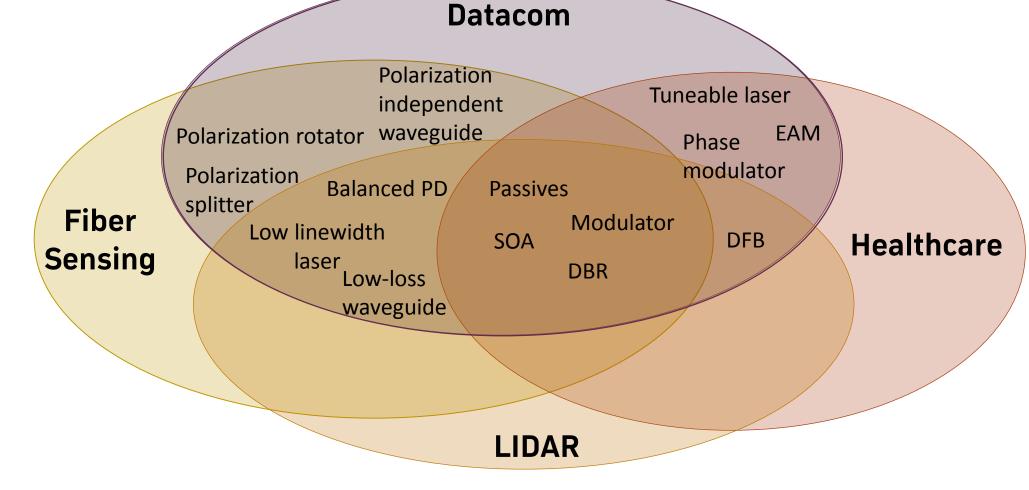
PROCESS DESIGN KIT APPROACH

- Generic Integration
 - Standardized industrial integration process
 - Design on functional level by using building block approach
 - Software design kits for fast and accurate design
 - Multi-project wafer (MPW) runs for early access prototyping
 - Enables easier scale up to high volume manufacturing
- PDK Building Block Library
 - For circuit simulation and mask design
 - Design manual and functional building block description
 - Full layout-aware design flow
 - Access via state of the art software tools





SHARED DEVELOPMENT ACROSS APPLICATION SPACES





SUMMARY

- Integrated photonics is growing rapidly and finding broader and higher volume applications
- Multiple factors are supporting a move to a foundry offer
- SMART Photonics has demonstrated blue print of pilot facility and is poised to fill the foundry role.
- We are investing heavily into growing capability and volumes as well as technology development

